

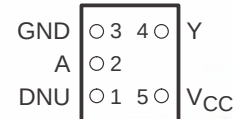
- Available in the Texas Instruments NanoStar™ and NanoFree™ Packages
- Optimized for 1.8-V Operation and Is 3.6-V I/O Tolerant to Support Mixed-Mode Signal Operation
- I_{off} Supports Partial-Power-Down Mode Operation
- Sub 1-V Operable
- Max t_{pd} of 2.5 ns at 1.8 V
- Low Power Consumption, 10- μ A Max I_{CC}
- ± 8 -mA Output Drive at 1.8 V
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)

DBV OR DCK PACKAGE
(TOP VIEW)



NC – No internal connection

YEA, YEP, YZA, OR YZP PACKAGE
(BOTTOM VIEW)



DNU – Do not use

description/ordering information

This single Schmitt-trigger inverter is operational at 0.8-V to 2.7-V V_{CC} , but is designed specifically for 1.65-V to 1.95-V V_{CC} operation.

The SN74AUC1G14 contains one inverter and performs the Boolean function $Y = \bar{A}$. The device functions as an independent inverter, but because of Schmitt action, it may have different input threshold levels for positive-going (V_{T+}) and negative-going (V_{T-}) signals.

NanoStar™ and NanoFree™ package technology is a major breakthrough in IC packaging concepts, using the die as the package.

ORDERING INFORMATION

T_A	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING‡
–40°C to 85°C	NanoStar™ – WCSP (DSBGA) 0.17-mm Small Bump – YEA	Tape and reel	SN74AUC1G14YEAR	—UF—
	NanoFree™ – WCSP (DSBGA) 0.17-mm Small Bump – YZA (Pb-free)		SN74AUC1G14YZAR	
	NanoStar™ – WCSP (DSBGA) 0.23-mm Large Bump – YEP		SN74AUC1G14YEPR	
	NanoFree™ – WCSP (DSBGA) 0.23-mm Large Bump – YZP (Pb-free)		SN74AUC1G14YZPR	
	SOT (SOT-23) – DBV	Tape and reel	SN74AUC1G14DBVR	U14_
	SOT (SC-70) – DCK	Tape and reel	SN74AUC1G14DCKR	UF_

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

‡ DBV/DCK: The actual top-side marking has one additional character that designates the assembly/test site.

YEA/YZA, YEP/YZP: The actual top-side marking has three preceding characters to denote year, month, and sequence code, and one following character to designate the assembly/test site. Pin 1 identifier indicates solder-bump composition (1 = SnPb, • = Pb-free).

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

SN74AUC1G14
SINGLE SCHMITT-TRIGGER INVERTER

SCES375J – SEPTEMBER 2001 – REVISED NOVEMBER 2003

description/ordering information (continued)

This device is fully specified for partial-power-down applications using I_{off} . The I_{off} circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

For more information about AUC Little Logic devices, please refer to the TI application report, *Applications of Texas Instruments AUC Sub-1-V Little Logic Devices*, literature number SCEA027.

FUNCTION TABLE	
INPUT A	OUTPUT Y
H	L
L	H

logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range, V_{CC}	–0.5 V to 3.6 V
Input voltage range, V_I (see Note 1)	–0.5 V to 3.6 V
Voltage range applied to any output in the high-impedance or power-off state, V_O (see Note 1)	–0.5 V to 3.6 V
Output voltage range, V_O (see Note 1)	–0.5 V to $V_{CC} + 0.5$ V
Input clamp current, I_{IK} ($V_I < 0$)	–50 mA
Output clamp current, I_{OK} ($V_O < 0$)	–50 mA
Continuous output current, I_O	±20 mA
Continuous current through V_{CC} or GND	±100 mA
Package thermal impedance, θ_{JA} (see Note 2): DBV package	206°C/W
DCK package	252°C/W
YEA/YZA package	154°C/W
YEP/YZP package	132°C/W
Storage temperature range, T_{stg}	–65°C to 150°C

[†] Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.
2. The package thermal impedance is calculated in accordance with JESD 51-7.

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recommended operating conditions (see Note 3)

		MIN	MAX	UNIT
V_{CC}	Supply voltage	0.8	2.7	V
V_I	Input voltage	0	3.6	V
V_O	Output voltage	0	V_{CC}	V
I_{OH}	High-level output current	$V_{CC} = 0.8\text{ V}$	–0.7	mA
		$V_{CC} = 1.1\text{ V}$	–3	
		$V_{CC} = 1.4\text{ V}$	–5	
		$V_{CC} = 1.65\text{ V}$	–8	
		$V_{CC} = 2.3\text{ V}$	–9	
I_{OL}	Low-level output current	$V_{CC} = 0.8\text{ V}$	0.7	mA
		$V_{CC} = 1.1\text{ V}$	3	
		$V_{CC} = 1.4\text{ V}$	5	
		$V_{CC} = 1.65\text{ V}$	8	
		$V_{CC} = 2.3\text{ V}$	9	
T_A	Operating free-air temperature	–40	85	°C

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS	V _{CC}	MIN	TYP [†]	MAX	UNIT
V _{T+} Positive-going input threshold voltage			0.8 V	0.5		V	
			1.1 V	0.51	0.86		
			1.4 V	0.65	1		
			1.65 V	0.79	1.16		
			2.3 V	1.11	1.56		
V _{T−} Negative-going input threshold voltage			0.8 V	0.3		V	
			1.1 V	0.22	0.53		
			1.4 V	0.3	0.58		
			1.65 V	0.39	0.62		
			2.3 V	0.58	0.87		
ΔV_T Hysteresis (V _{T+} − V _{T−})			0.8 V	0.21		V	
			1.1 V	0.25	0.38		
			1.4 V	0.31	0.5		
			1.65 V	0.37	0.62		
			2.3 V	0.48	0.77		
V _{OH}		I _{OH} = −100 μA I _{OH} = −0.7 mA I _{OH} = −3 mA I _{OH} = −5 mA I _{OH} = −8 mA I _{OH} = −9 mA	0.8 V to 2.7 V	V _{CC} −0.1		V	
			0.8 V	0.55			
			1.1 V	0.8			
			1.4 V	1			
			1.65 V	1.2			
			2.3 V	1.8			
			V _{OL}		I _{OL} = 100 μA I _{OL} = 0.7 mA I _{OL} = 3 mA I _{OL} = 5 mA I _{OL} = 8 mA I _{OL} = 9 mA		0.8 V to 2.7 V
0.8 V	0.25						
1.1 V	0.3						
1.4 V	0.4						
1.65 V	0.45						
2.3 V	0.6						
I _I	A input	V _I = V _{CC} or GND				0 to 2.7 V	±5
I _{off}		V _I or V _O = 2.7 V	0	±10		μA	
I _{CC}		V _I = V _{CC} or GND, I _O = 0	0.8 V to 2.7 V	10		μA	
C _i		V _I = V _{CC} or GND	2.5 V	3.5		pF	

[†] All typical values are at T_A = 25°C.

switching characteristics over recommended operating free-air temperature range, C_L = 15 pF (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC} = 0.8 V	V _{CC} = 1.2 V ± 0.1 V		V _{CC} = 1.5 V ± 0.1 V		V _{CC} = 1.8 V ± 0.15 V			V _{CC} = 2.5 V ± 0.2 V		UNIT
			TYP	MIN	MAX	MIN	MAX	MIN	TYP	MAX	MIN	MAX	
t _{pd}	A	Y	5.8	0.7	4	0.6	2.3	‡	‡	‡	‡	‡	ns

[‡] This information was not available at the time of publication.

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SINGLE SCHMITT-TRIGGER INVERTER

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switching characteristics over recommended operating free-air temperature range, $C_L = 30 \text{ pF}$ (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CC} = 1.8 \text{ V}$ $\pm 0.15 \text{ V}$			$V_{CC} = 2.5 \text{ V}$ $\pm 0.2 \text{ V}$		UNIT
			MIN	TYP	MAX	MIN	MAX	
t_{pd}	A	Y	0.7	1.6	2.5	0.5	2.5	ns

operating characteristics, $T_A = 25^\circ\text{C}$

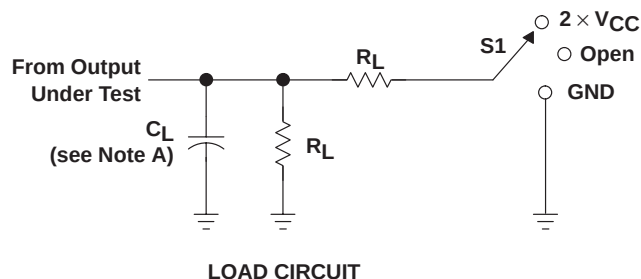
PARAMETER		TEST CONDITIONS	$V_{CC} = 0.8 \text{ V}$	$V_{CC} = 1.2 \text{ V}$	$V_{CC} = 1.5 \text{ V}$	$V_{CC} = 1.8 \text{ V}$	$V_{CC} = 2.5 \text{ V}$	UNIT
			TYP	TYP	TYP	TYP	TYP	
C_{pd}	Power dissipation capacitance	$f = 10 \text{ MHz}$	14	15	15	16	19	pF

SN74AUC1G14

SINGLE SCHMITT-TRIGGER INVERTER

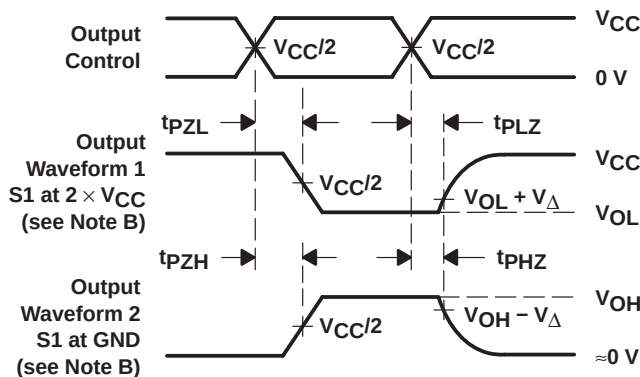
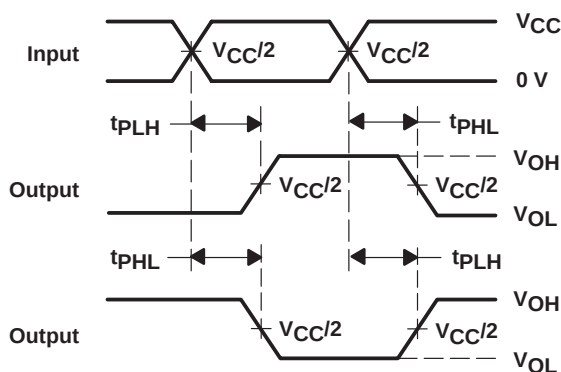
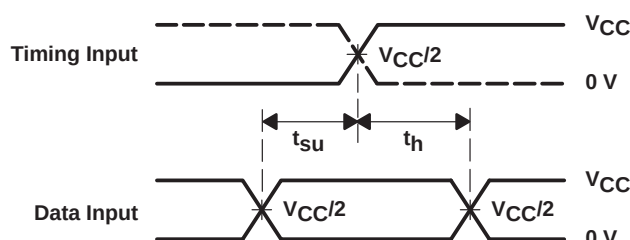
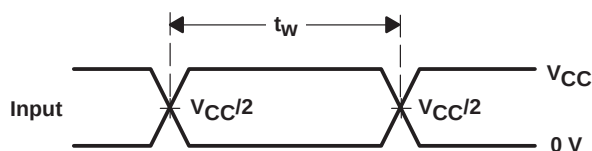
SCES375J – SEPTEMBER 2001 – REVISED NOVEMBER 2003

PARAMETER MEASUREMENT INFORMATION



TEST	S1
t_{PLH}/t_{PHL}	Open
t_{PLZ}/t_{PZL}	$2 \times V_{CC}$
t_{PHZ}/t_{PZH}	GND

V_{CC}	C_L	R_L	V_{Δ}
0.8 V	15 pF	2 k Ω	0.1 V
1.2 V $\pm$ 0.1 V	15 pF	2 k Ω	0.1 V
1.5 V $\pm$ 0.1 V	15 pF	2 k Ω	0.1 V
1.8 V $\pm$ 0.15 V	15 pF	2 k Ω	0.15 V
2.5 V $\pm$ 0.2 V	15 pF	2 k Ω	0.15 V
1.8 V $\pm$ 0.15 V	30 pF	1 k Ω	0.15 V
2.5 V $\pm$ 0.2 V	30 pF	500 Ω	0.15 V



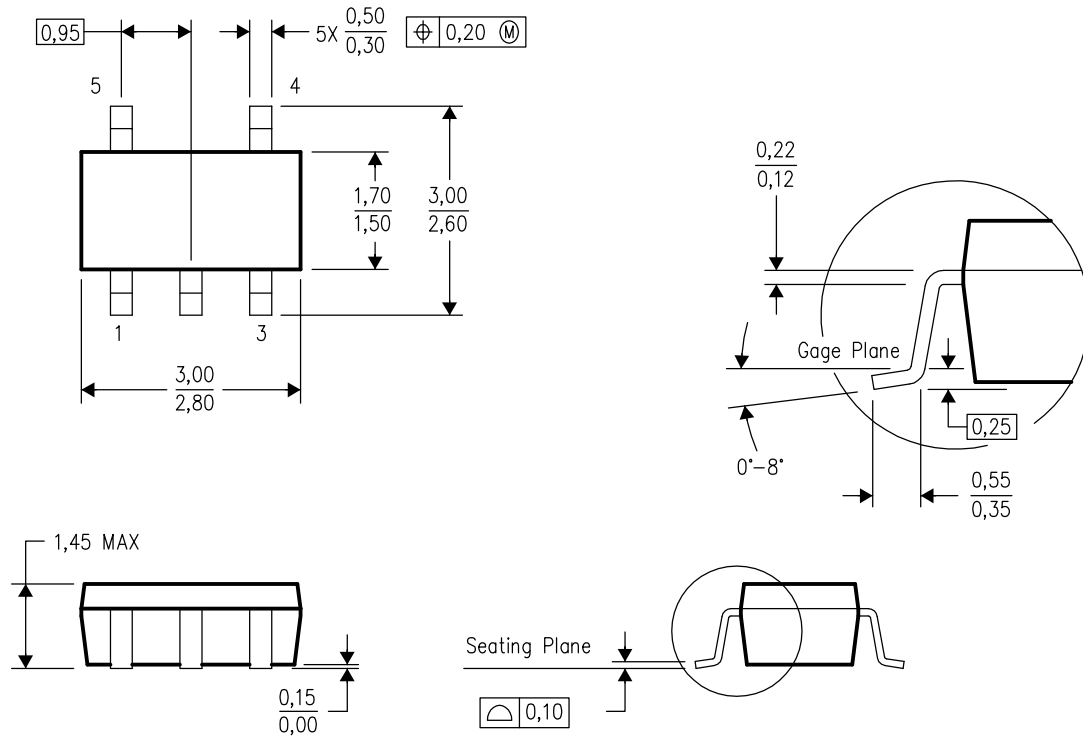
- NOTES:
- C_L includes probe and jig capacitance.
 - Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - All input pulses are supplied by generators having the following characteristics: $PRR \leq 10 \text{ MHz}$, $Z_O = 50 \Omega$, slew rate $\geq 1 \text{ V/ns}$.
 - The outputs are measured one at a time with one transition per measurement.
 - t_{PLZ} and t_{PHZ} are the same as t_{dis} .
 - t_{PZL} and t_{PZH} are the same as t_{en} .
 - t_{PLH} and t_{PHL} are the same as t_{pd} .
 - All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms

MECHANICAL DATA

DBV (R-PDSO-G5)

PLASTIC SMALL-OUTLINE PACKAGE



4073253-4/H 10/2003

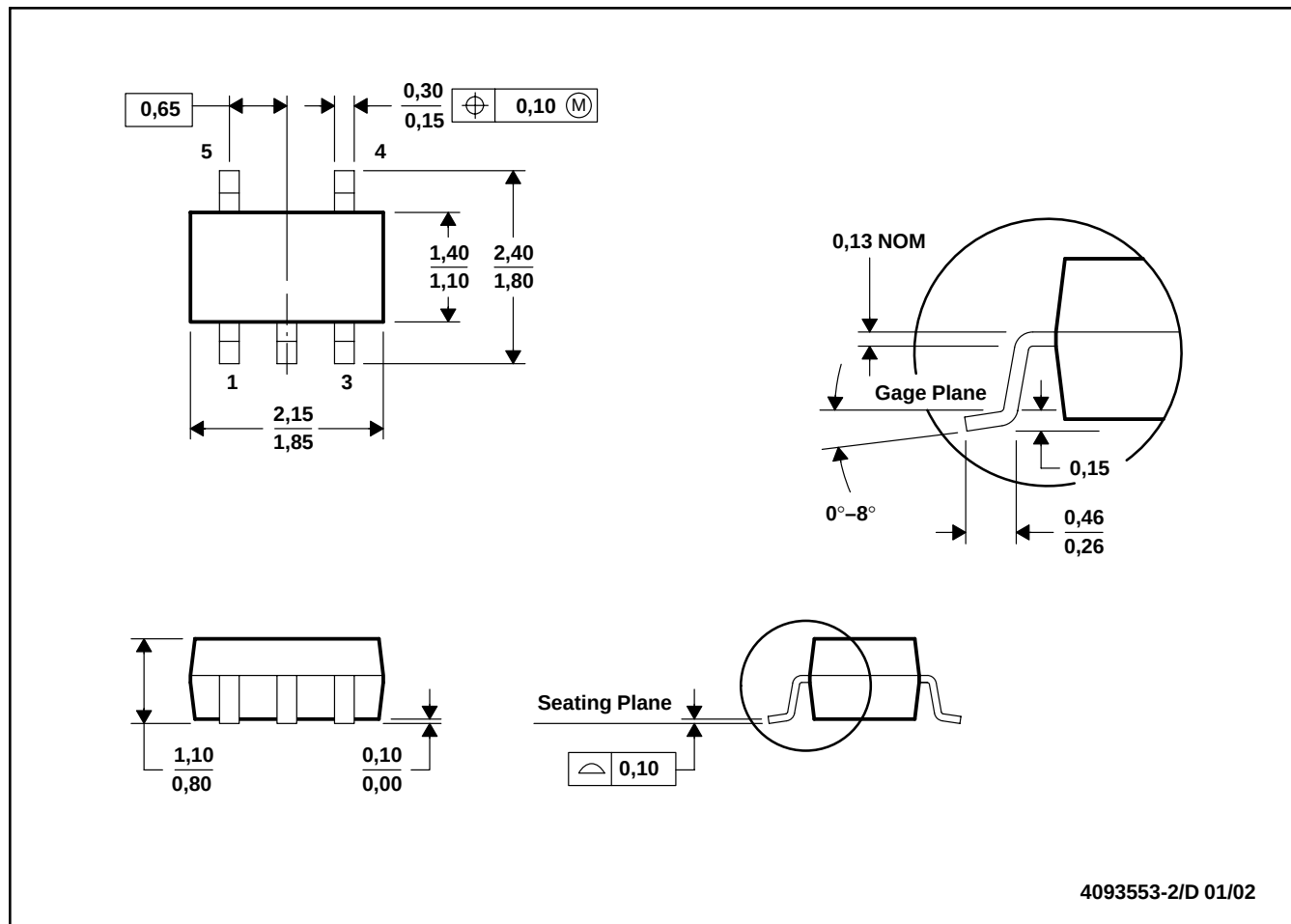
- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion.
 - D. Falls within JEDEC MO-178 Variation AA.

MECHANICAL DATA

MPDS025C – FEBRUARY 1997 – REVISED FEBRUARY 2002

DCK (R-PDSO-G5)

PLASTIC SMALL-OUTLINE PACKAGE

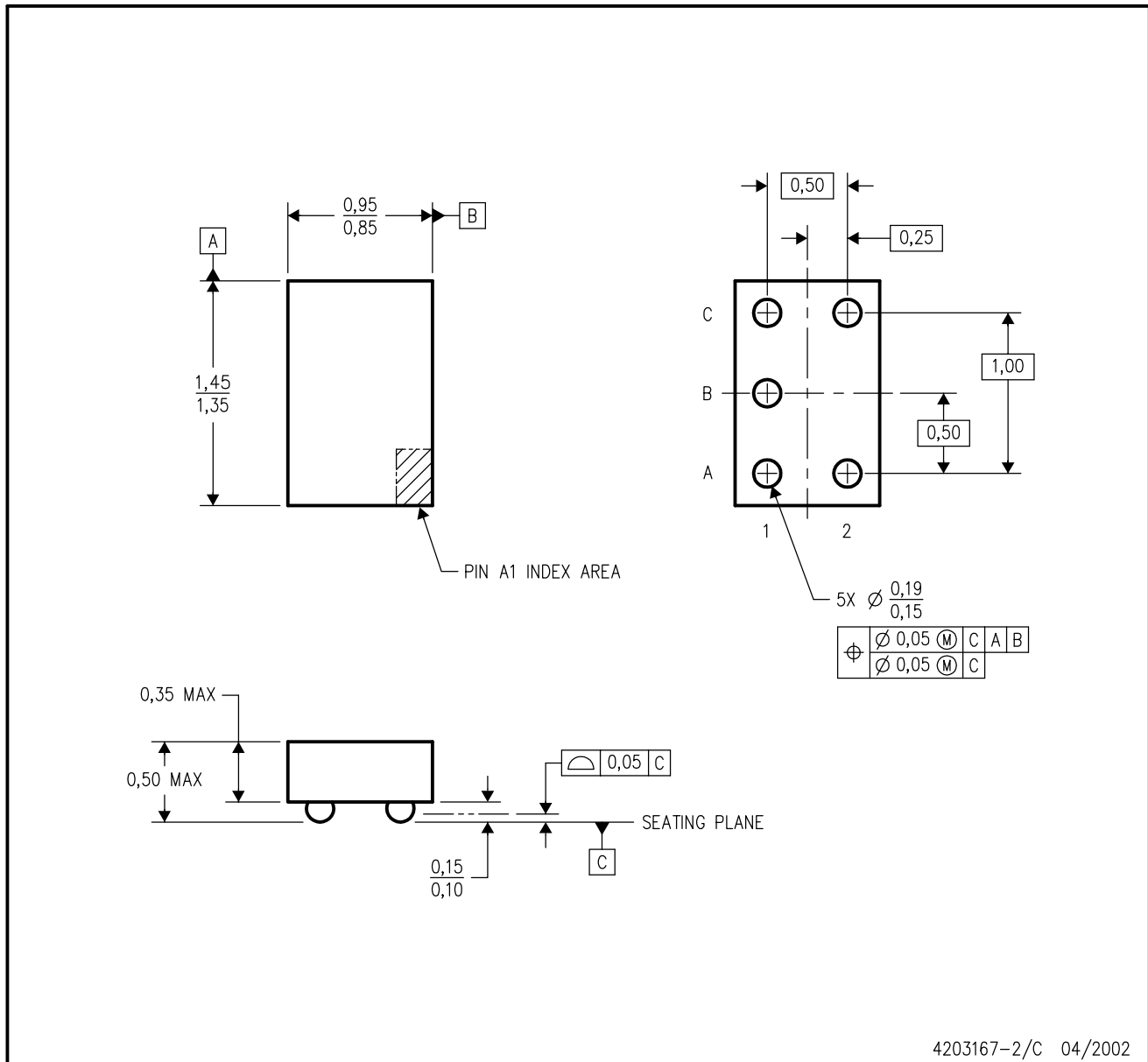


- NOTES:
- All linear dimensions are in millimeters.
 - This drawing is subject to change without notice.
 - Body dimensions do not include mold flash or protrusion.
 - Falls within JEDEC MO-203

MECHANICAL DATA

YEA (R-XBGA-N5)

DIE-SIZE BALL GRID ARRAY



4203167-2/C 04/2002

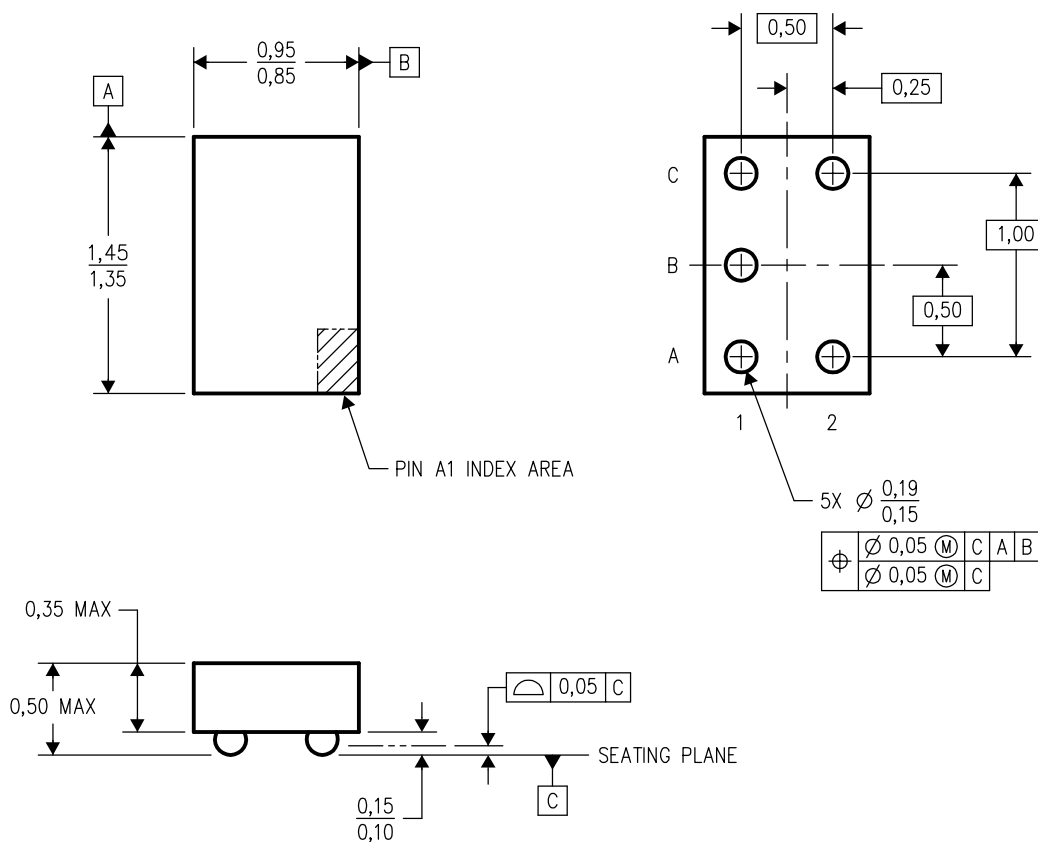
- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. NanoStar™ package configuration.
 - D. Package complies to JEDEC MO-211 variation EA.
 - E. This package is tin-lead (SnPb). Refer to the 5 YZA package (drawing 4204151) for lead-free.

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MECHANICAL DATA

YZA (R-XBGA-N5)

DIE-SIZE BALL GRID ARRAY



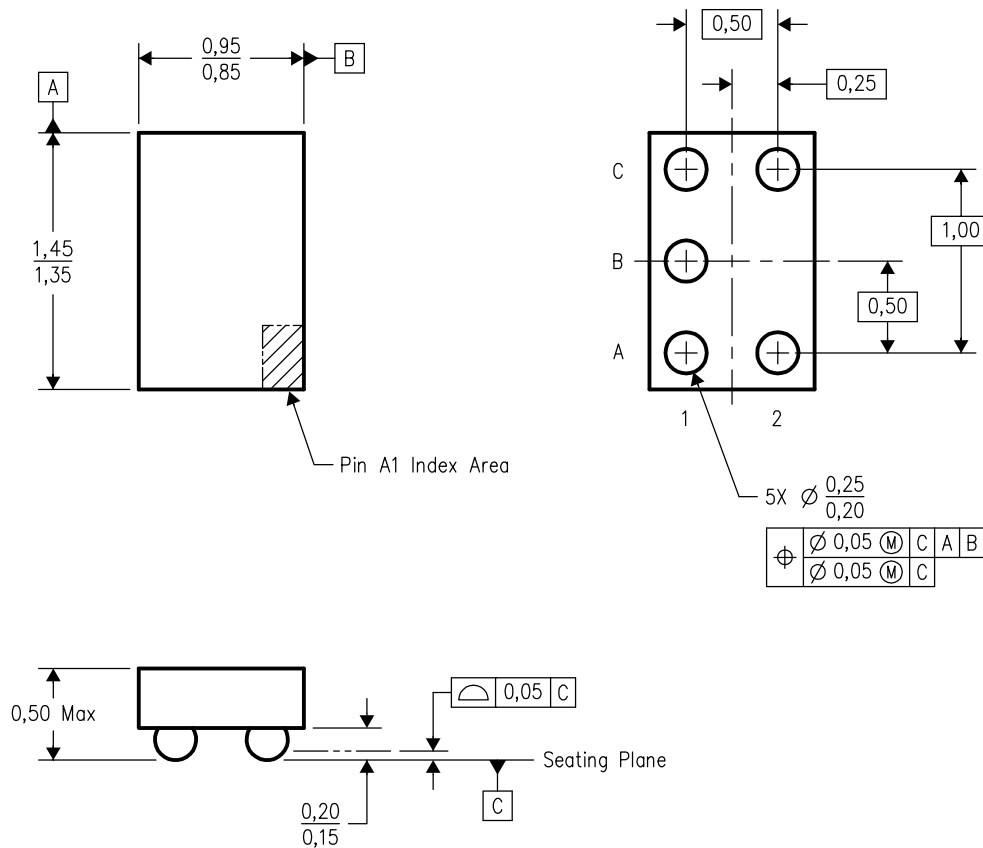
4204151-2/B 03/2002

- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. NanoFree™ package configuration.
 - D. Package complies to JEDEC MO-211 variation EA.
 - E. This package is lead-free. Refer to the 5 YEA package (drawing 4203167) for tin-lead (SnPb).

MECHANICAL DATA

YZP (R-XBGA-N5)

DIE-SIZE BALL GRID ARRAY



4204741-2/A 10/2002

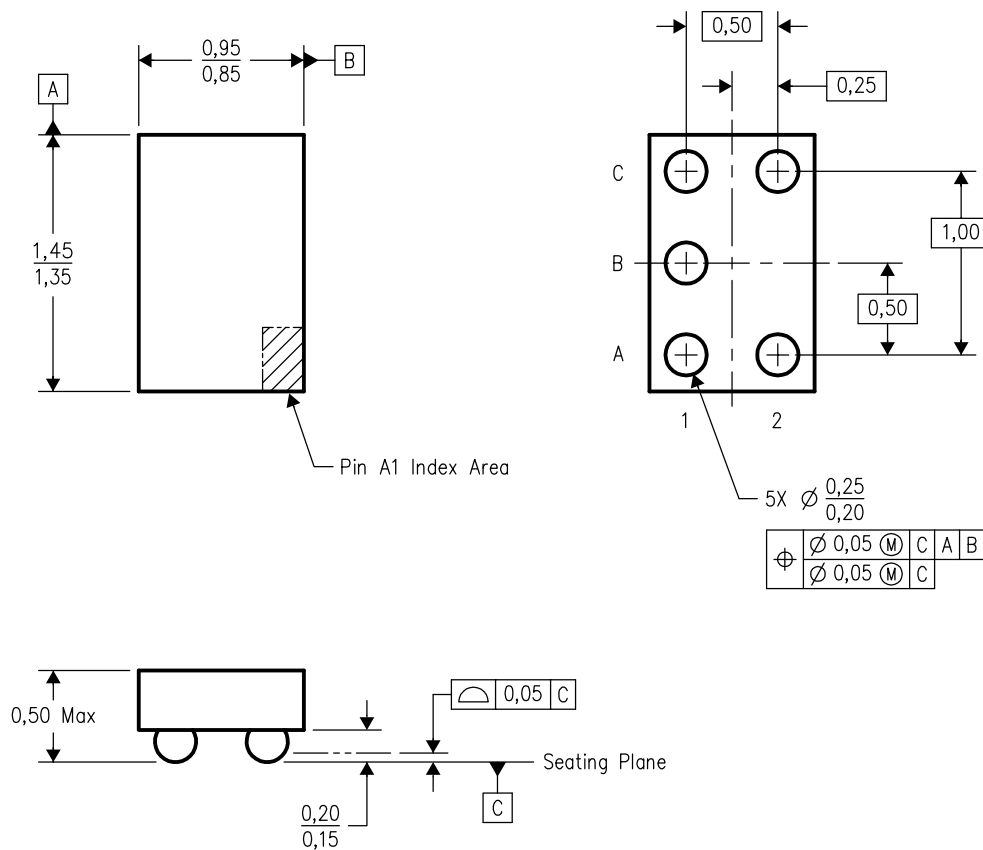
- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. NanoFree™ package configuration.
 - D. This package is lead-free. Refer to the 5 YEP package (drawing 4204725) for tin-lead (SnPb).

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MECHANICAL DATA

YEP (R-XBGA-N5)

DIE-SIZE BALL GRID ARRAY



4204725-2/A 10/2002

- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. NanoStar™ package configuration.
 - D. This package is tin-lead (SnPb). Refer to the 5 YZP package (drawing 4204741) for lead-free.

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